

D35XB80

Bridge Diodes

800V, 35A

Feature

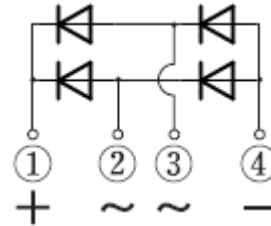
- Compact SIP
- UL E142422
- High Current
- High heat dissipation
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 5S



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T _{stg}		-55 to 150	°C
Junction temperature	T _j		-55 to 150	°C
Repetitive peak reverse voltage	V _{RRM}		800	V
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, With heatsink, T _c =93°C	35	A
Average forward current	I _{F(AV)}	50Hz sine wave, Resistance load, On glass-epoxy substrate, T _a =25°C ※	3	A
Surge forward current	I _{FSM}	50Hz sine wave, Non-repetitive 1 cycle peak value, T _j =25°C	550	A
Surge forward current	I _{FSM}	60Hz sine wave, Non-repetitive 1 cycle peak value, T _j =25°C	603	A
Current squared time	I ² t	1ms ≤ tp < 10ms, T _j =25°C, per diode	1512	A ² s
Dielectric strength	V _{dis}	Terminals to case backside, AC 1 minute	2.5	kV
Mounting torque	TOR	(Recommended torque : 0.5N·m)	0.8	N·m

※ : See the original Specifications

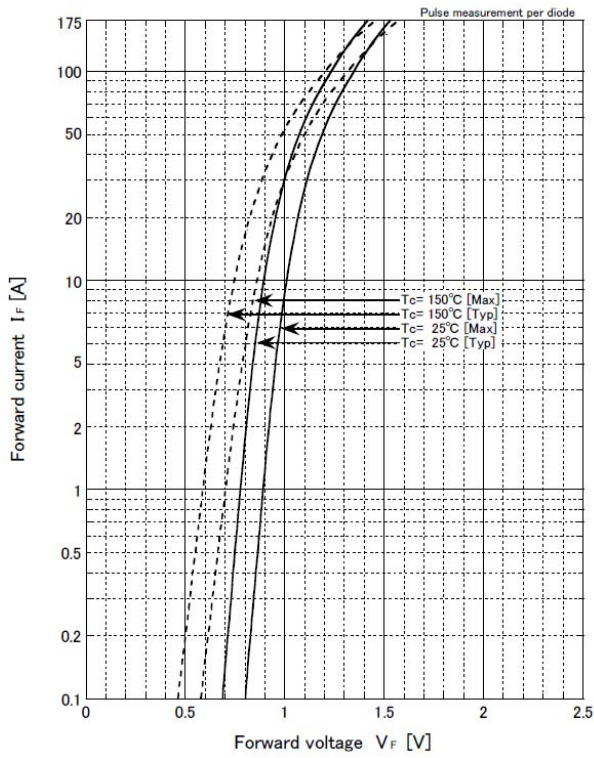
Electrical Characteristics (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V_F	IF=17.5A, Pulse measurement, per diode			1.05	V
Reverse current	I_R	VR=800V, Pulse measurement, per diode			10	μA
Reverse recovery time	trr	IF=0.1A, IR=0.1A, 0.1IRP, per diode			27000	ns
Thermal resistance	Rth(j-c)	Junction to case, With heatsink			0.8	°C/W
Thermal resistance	Rth(j-l)	Junction to lead, Without heatsink, On glass-epoxy substrate ※			5.2	°C/W
Thermal resistance	Rth(j-a)	Junction to ambient, Without heatsink, On glass-epoxy substrate ※			25	°C/W

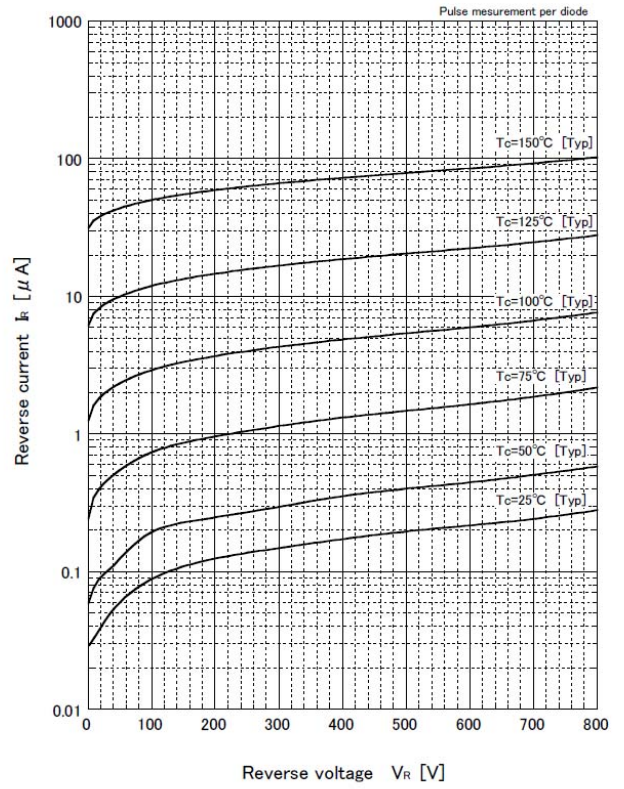
※ :See the original Specifications

CHARACTERISTIC DIAGRAMS

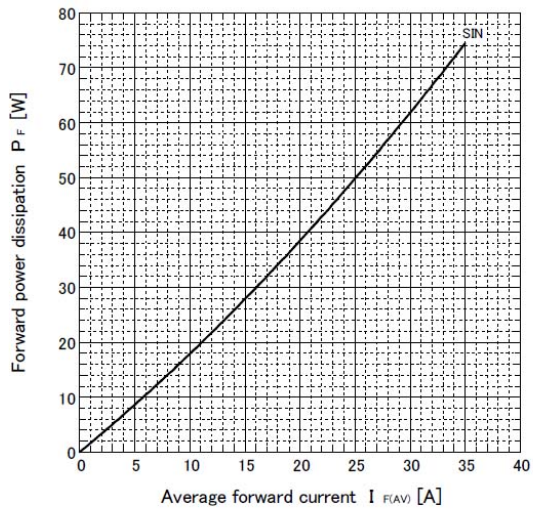
Forward voltage



Reverse current

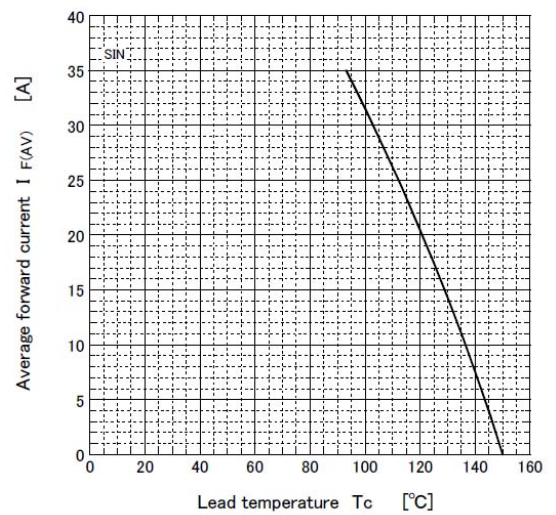


Forward power dissipation



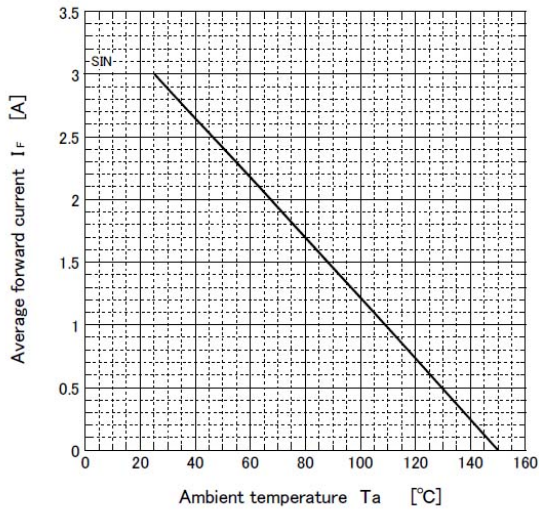
● $T_J = 150^\circ\text{C}$

Derating curve



● $V_R = 800\text{V}$
 R-load
 With heatsink

Derating curve

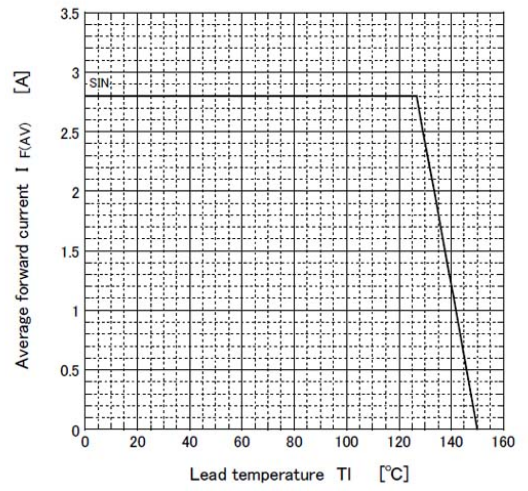


● $V_R = 800V$
R-load
Free in air

● Substrate detail

Type	Glass-epoxy
Size	90mm × 150mm
Thickness	1mm
Conductor thickness	35 μ m
Pattern area	1107mm ²

Derating curve

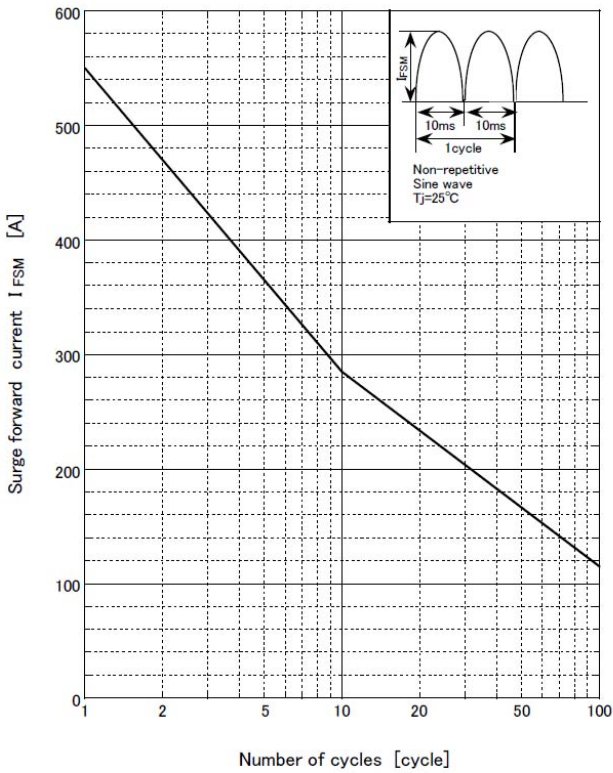


● $V_R = 800V$
R-load
Free in air

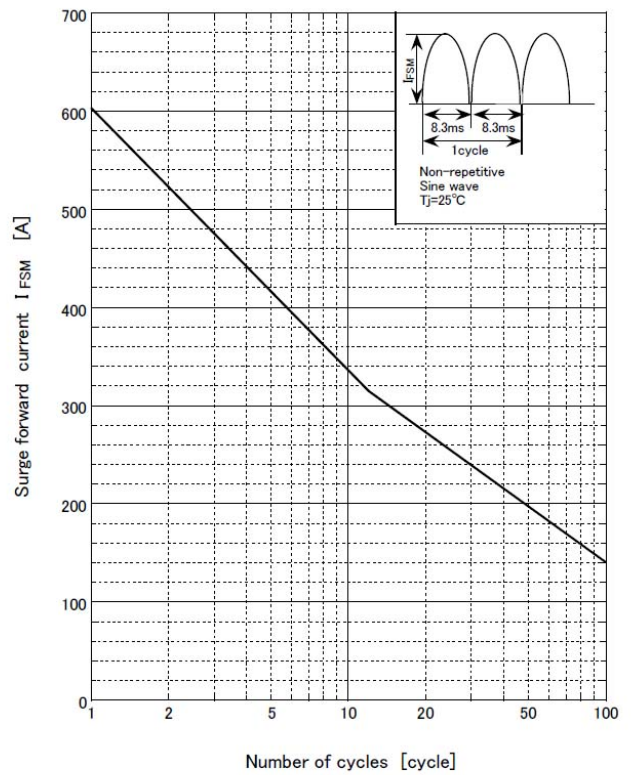
● Substrate detail

Type	Glass-epoxy
Size	90mm × 150mm
Thickness	1mm
Conductor thickness	35 μ m
Pattern area	1107mm ²

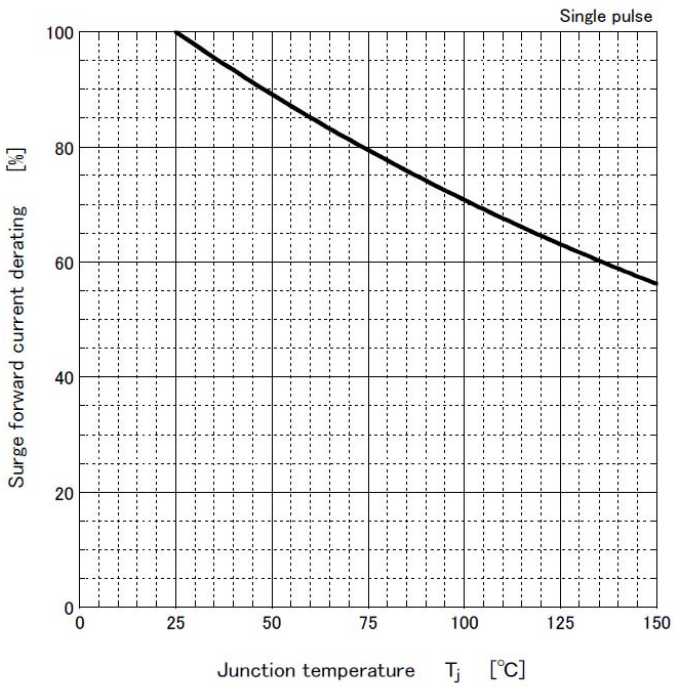
Surge forward current capability



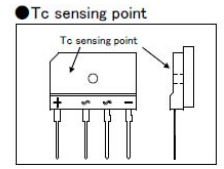
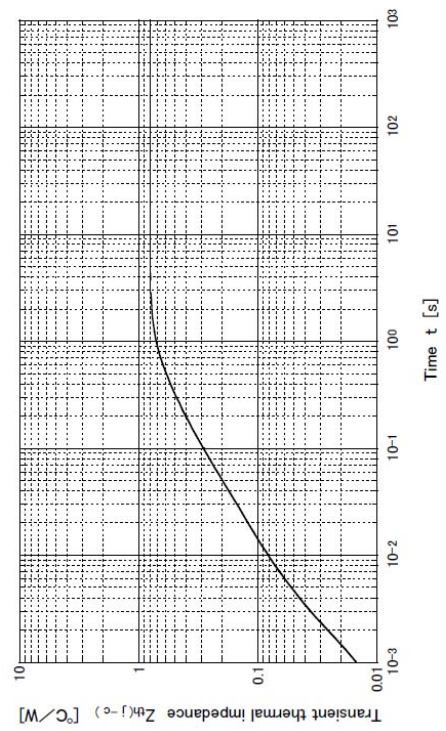
Surge forward current capability



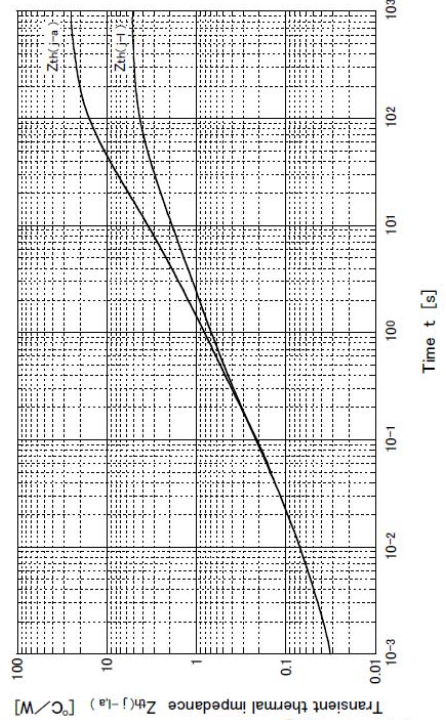
Surge forward current derating
vs Junction temperature



Transient thermal impedance

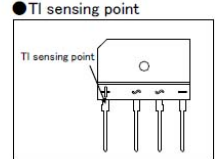


Transient thermal impedance



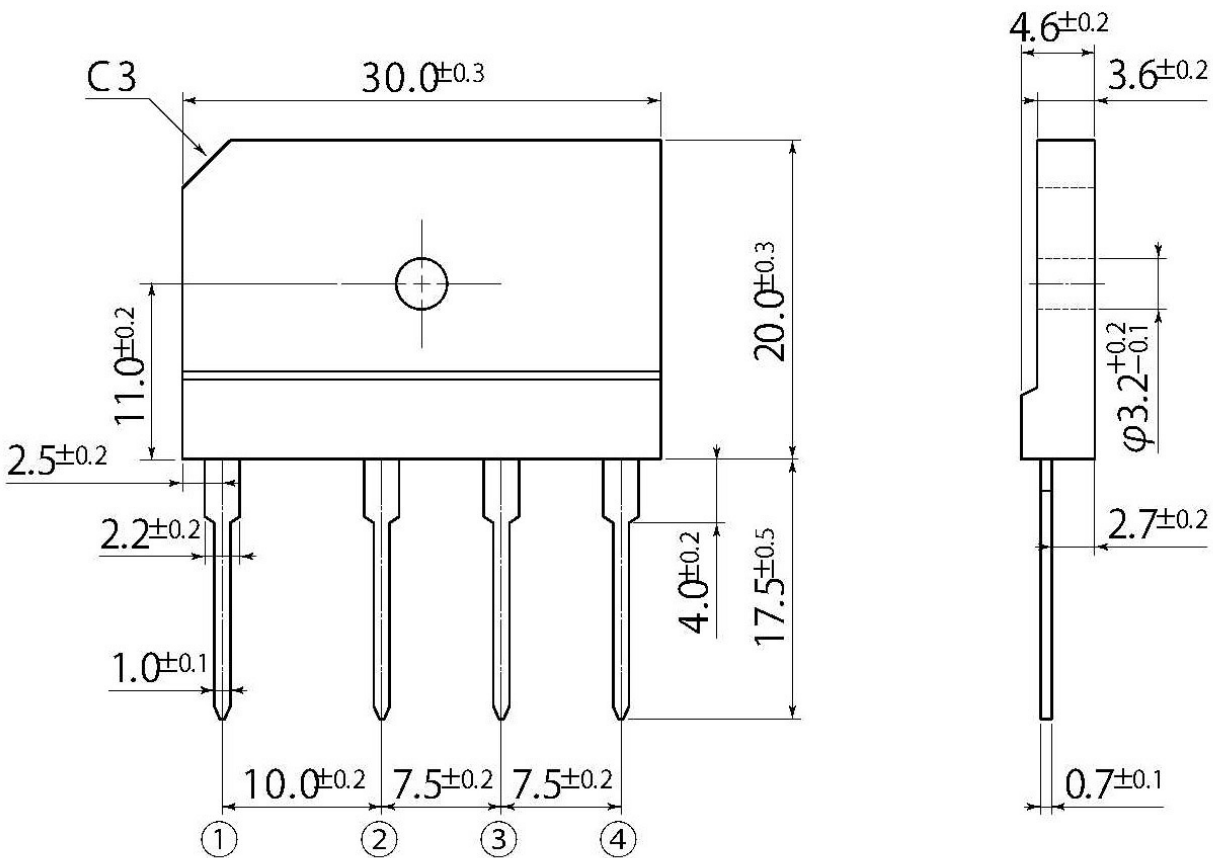
● Substrate detail

Type	Glass-epoxy
Size	90mm X 150mm
Thickness	1mm
Conductor thickness	35μm
Pattern area	1107mm ²



D4

JEDEC Code	—
JEITA Code	—
House Name	5S



Notes

1. If you wish to use any such product, please be sure to refer to the specifications issued by Shindengen.
2. All products described or contained herein are designed with a quality level intended for use in standard applications requiring an ordinary level of reliability. If these products are to be used in equipment or devices for special or specific applications requiring an extremely high grade of quality or reliability in which failures or malfunctions of products may directly affect human life or health, a local Shindengen office must be contacted in advance to confirm that the intended use of the product is appropriate. Shindengen products are grouped into the following three applications according to the quality grade.
 - 【Standard applications】
Computers, office automation and other office equipment, communication terminals, test and measurement equipment, audio/visual equipment, amusement equipment, consumer electronics, machine tools, personal electronic equipment, industrial equipment, etc.
 - 【Special applications】
Transportation equipment (vehicles, ships, etc.), trunk-line communication equipment, traffic signal control systems, anti-disaster/crime systems, safety equipment, medical equipment, etc.
 - 【Specific applications】
Nuclear reactor control systems, aircraft, aerospace equipment, submarine repeaters, life support equipment and systems, etc.
3. Although Shindengen continuously endeavors to enhance the quality and reliability of its products, customers are advised to consider and take safety measures in their design, such as redundancy, fire containment and anti-failure, so that personal injury, fires, or societal damages can be prevented.
4. Please note that all information described or contained herein is subject to change without notice due to product upgrades and other reasons. When buying Shindengen products, please contact the Company's offices or distributors to obtain the latest information.
5. Shindengen shall not bear any responsibility with regards to damages or infringement of any third-party patent rights and other intellectual property rights incurred due to the use of information on this website.
6. The information and materials on this website neither warrant the use of Shindengen's or any third party's patent rights and other intellectual property rights, nor grant license to such rights.
7. In the event that any product described or contained herein falls under the category of strategic products controlled under the Foreign Exchange and Foreign Trade Control Law of Japan, exporting of such products shall require an export license from the Japanese government in accordance with the above law.
8. No reprinting or reproduction of the materials on this website, either in whole or in part, is permitted without proper authorization from Shindengen.